



US 20040141326A1

(19) **United States**(12) **Patent Application Publication**
Dry(10) **Pub. No.: US 2004/0141326 A1**(43) **Pub. Date: Jul. 22, 2004**(54) **LIGHT EMITTING DIODE LIGHT SOURCE**

No. 10/156,810, filed on May 29, 2002, now Pat. No. 6,573,536.

(75) Inventor: **Joel M. Dry**, New Orleans, LA (US)

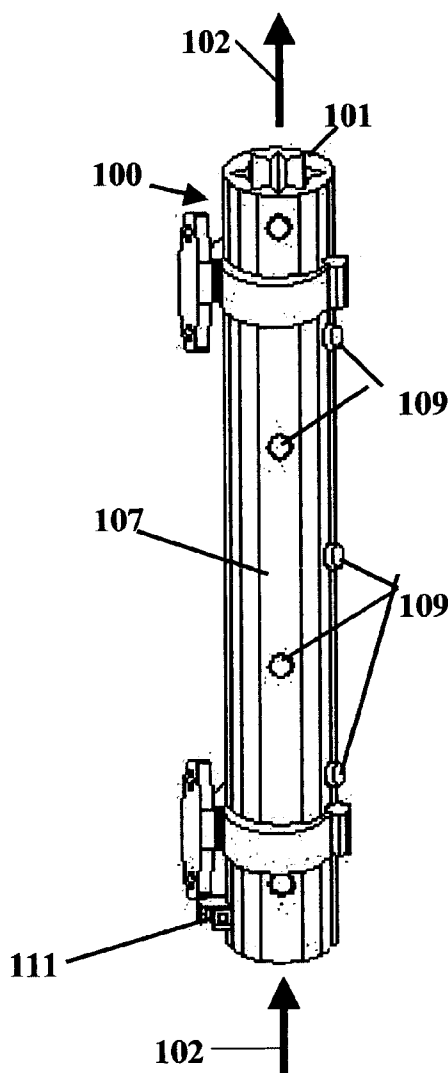
Correspondence Address:

DONALD J. LENKSZUS**PO BOX 3064****CAREFREE, AZ 85377-3064 (US)****Publication Classification**(51) **Int. Cl.⁷** **B60Q 1/06**(52) **U.S. Cl.** **362/373**(73) Assignee: **OPTOLUM, INC.**, Scottsdale, AZ(21) Appl. No.: **10/631,027**(22) Filed: **Jul. 30, 2003****Related U.S. Application Data**

(63) Continuation of application No. 10/430,732, filed on May 5, 2003, which is a continuation of application

(57) **ABSTRACT**

A light or radiation emitting source that utilizes radiation emitting solid state or semiconductor devices is disclosed. The devices are mounted on an elongate member having at least two surfaces upon which the light emitting diodes are mounted. The elongate member is thermally conductive and is utilized to cool the devices. In the illustrative embodiment, the elongate member is a tubular member through which a heat transfer medium flows.



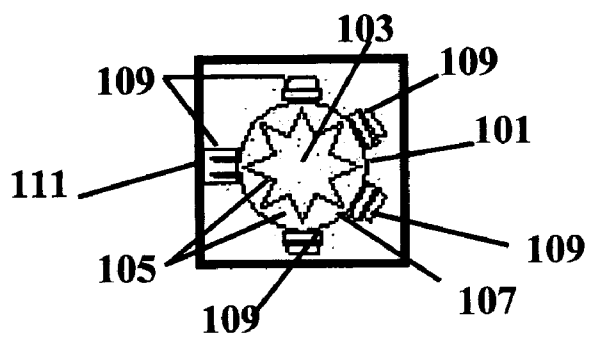


FIG. 2

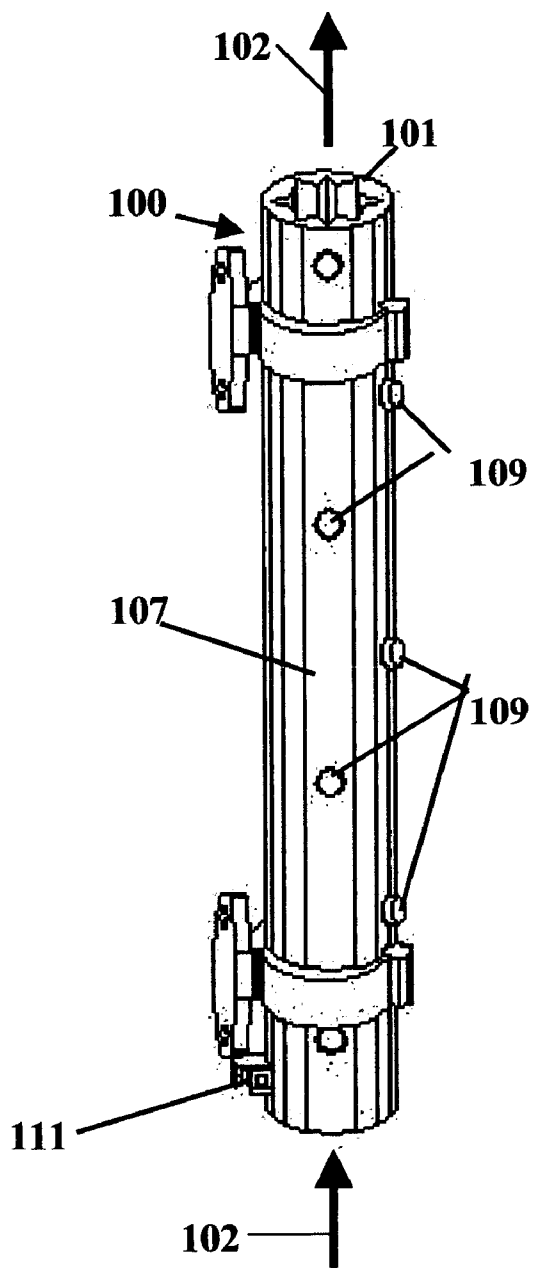


FIG. 3

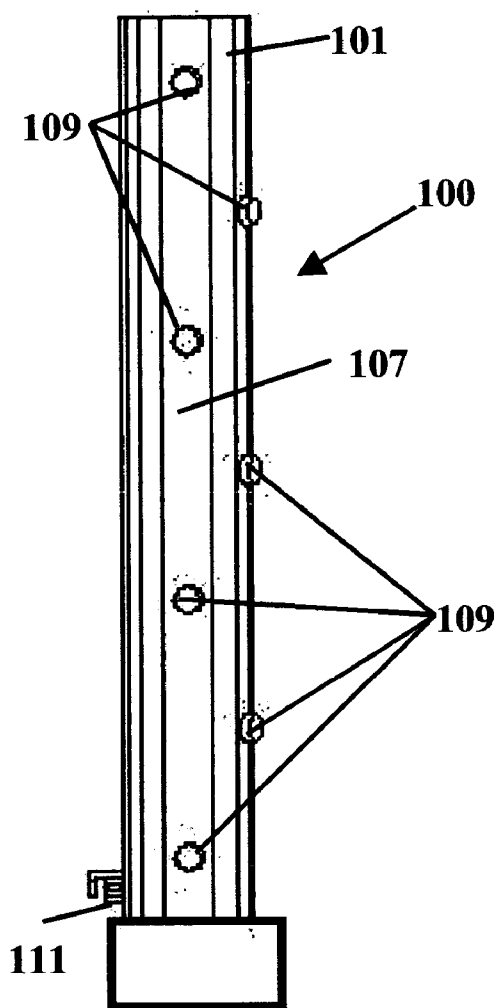


FIG. 1

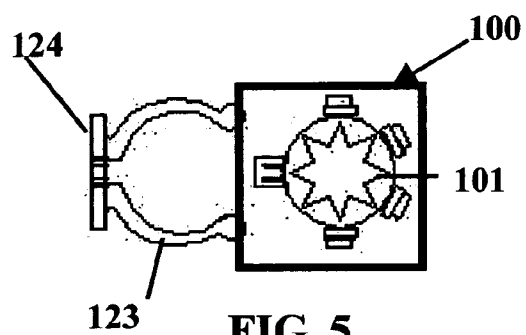


FIG. 5

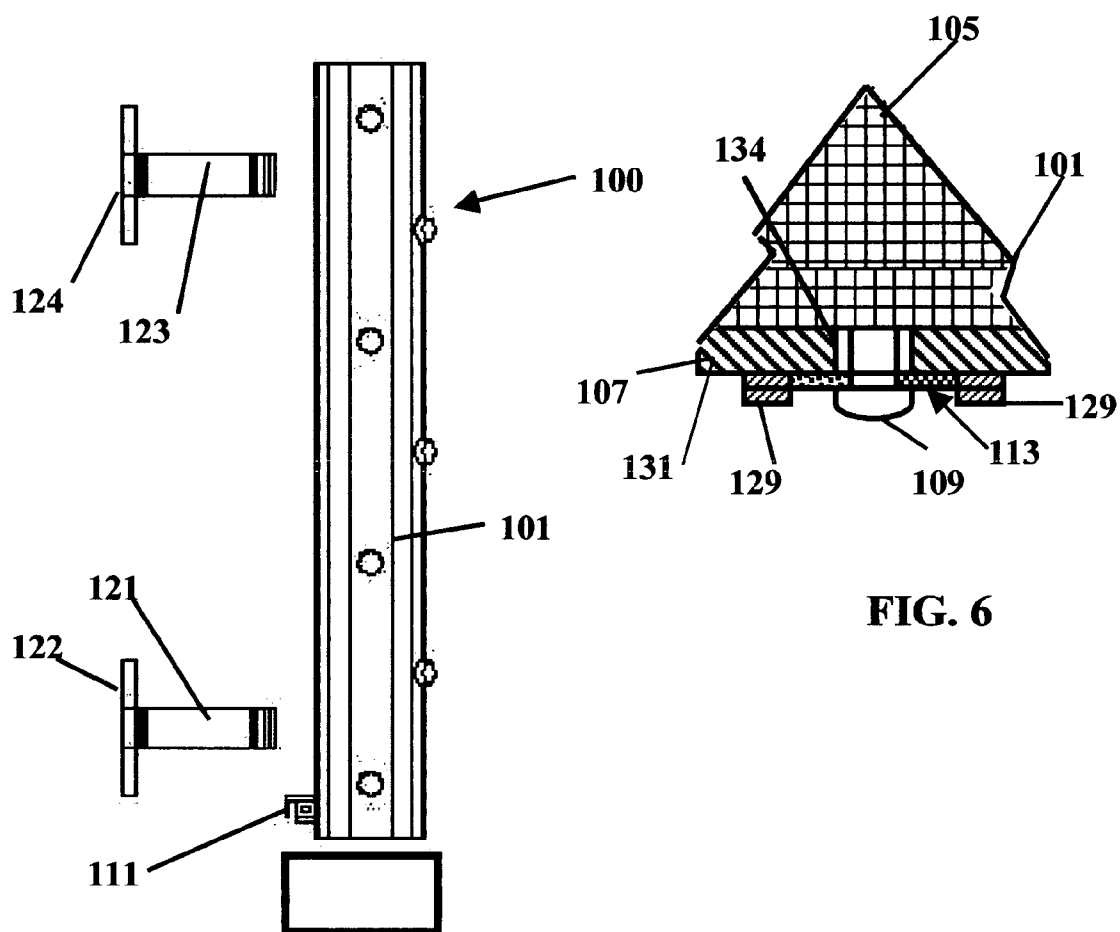


FIG. 6

FIG. 4

LIGHT EMITTING DIODE LIGHT SOURCE

RELATED APPLICATIONS

[0001] This application is a continuation of my co-pending application Ser. No. 10/430,732, filed May 5, 2003 which is a continuation of application Ser. No. 10/156,810 filed May 29, 2002, now U.S. Pat. No. 6,573,536 issued Jun. 3, 2003.

FIELD OF THE INVENTION

[0002] This invention pertains to lighting sources, in general, and to a lighting source that utilizes Light Emitting Diodes (LED's), in particular.

BACKGROUND OF THE INVENTION

[0003] LED's have many advantages as light sources. However, in the past LED's have found application only as specialized light sources such as for vehicle brake lights, and other vehicle related lighting, and recently as flashlights. In these prior applications, the LED's are typically mounted in a planar fashion in a single plane that is disposed so as to be perpendicular to the viewing area. Typically the LED planar array is not used to provide illumination, but to provide signaling.

[0004] Recent attempts to provide LED light sources as sources of illumination have been few, and generally unsatisfactory from a general lighting standpoint.

[0005] It is highly desirable to provide a light source utilizing LED's that provides sufficient light output so as to be used as a general lighting source rather than as a signaling source.

[0006] One problem that has limited the use of LED's to specialty signaling and limited general illumination sources is that LED's typically generate significant amounts of heat. The heat is such that unless the heat is dissipated, the LED internal temperature will rise causing degradation or destruction of the LED.

[0007] It is therefore further desirable to provide an LED light source that efficiently conducts heat away from the LED's.

SUMMARY OF THE INVENTION

[0008] In accordance with the principles of the invention, an improved light source is provided. The light source includes an elongate thermally conductive member having an outer surface. A plurality of light emitting diodes is carried on the elongate member outer surface. At least some of the light emitting diodes are disposed in a first plane and others of said light emitting diodes are disposed in a second plane not coextensive with the first plane. Electrical conductors are carried by the elongate thermally conductive member and are connected to the plurality of light emitting diodes to supply electrical power thereto. The elongate thermally conductive member conducts heat away from the light emitting diodes.

[0009] In accordance with one aspect of the invention, an illustrative embodiment of the invention utilizes light emitting diodes that emit white light. However, other embodiments of the invention may utilize light emitting diodes that are of different colors to produce monochromatic light or the colors may be chosen to produce white light or other colors.

[0010] In accordance with another aspect of the invention the elongate thermally conductive member transfers heat from the light emitting diodes to a medium within said elongate thermally conductive member. In the illustrative embodiment of the invention, the medium is air.

[0011] In accordance with another aspect of the invention, the elongate thermally conductive member has one or more fins to enhance heat transfer to the medium.

[0012] In accordance with another aspect of the invention the elongate thermally conductive member comprises a tube. In one embodiment of the invention, the tube has a cross-section in the shape of a polygon. In another embodiment of the invention, the tube has a cross-section having flat portions.

[0013] In accordance with another embodiment of the invention, the elongate thermally conductive member comprises a channel.

[0014] In accordance with the principles of the invention, the elongate thermally conductive member may comprise an extrusion, and the extrusion can be highly thermally conductive material such as aluminum.

[0015] In one preferred embodiment of the invention the elongate thermally conductive member is a tubular member. The tubular member has a polygon cross-section. However, other embodiments may have a tubular member of triangular cross-section.

[0016] In one embodiment of the invention, a flexible circuit is carried on a surface of said elongate thermally conductive member; the flexible circuit includes the electrical conductors.

[0017] In another aspect of the invention, the flexible circuit comprises a plurality of apertures for receiving said plurality of light emitting diodes. Each of the light emitting diodes is disposed in a corresponding one of the apertures and affixed in thermally conductive contact with said elongate thermally conductive member.

[0018] The elongate thermally conductive member includes a thermal transfer media disposed therein in a flow channel.

[0019] At least one clip for mounting the elongate thermally conductive member in a fixture may be included.

BRIEF DESCRIPTION OF THE DRAWING

[0020] The invention will be better understood from a reading of the following detailed description of a preferred embodiment of the invention taken in conjunction with the drawing figures, in which like reference indications identify like elements, and in which:

[0021] FIG. 1 is a planar side view of a light source in accordance with the principles of the invention;

[0022] FIG. 2 is a top planar view of the light source of FIG. 1;

[0023] FIG. 3 is a perspective view of the light source of FIG. 1 with mounting clips;

[0024] FIG. 4 is a planar side view of the light source of FIG. 3 showing mounting clips separated from the light source;

[0025] FIG. 5 is a top view of the light source and mounting clips of FIG. 4; and

[0026] FIG. 6 is a partial cross-section of the light source of FIG. 1.

DETAILED DESCRIPTION

[0027] A light source in accordance with the principles of the invention may be used as a decorative lighting element or may be utilized as a general illumination device. As shown in FIG. 1, a light source 100 in accordance with the invention includes an elongate thermally conductive member or heat sink 101. Elongate heat sink 101 is formed of a material that provides excellent thermal conductivity. Elongate heat sink 101 in the illustrative embodiment of the invention is a tubular aluminum extrusion. To improve the heat dissipative properties of light source 100, elongate heat sink 101 is configured to provide convective heat dissipation and cooling. As more clearly seen in FIG. 2, tubular heat sink 101 is hollow and has an interior cavity 103 that includes one or more heat dissipating fins 105. Fins 105 are shown as being triangular in shape, but may take on other shapes. Fins 105 are integrally formed on the interior of elongate heat sink 101. In the illustrative embodiment convective cooling is provided by movement of a medium 102 through elongate heat sink 101. The medium utilized in the illustrative embodiment is air, but may in some applications be a fluid other than air to provide for greater heat dissipation and cooling.

[0028] The exterior surface 107 of elongate heat sink 101 has a plurality of Light Emitting Diodes 109 disposed thereon. Each LED 109 in the illustrative embodiment comprises a white light emitting LED of a type that provides a high light output. Each LED 109 also generates significant amount of heat that must be dissipated to avoid thermal destruction of the LED. By combining a plurality of LEDs 109 on elongate heat sink 101, a high light output light source that may be used for general lighting is provided.

[0029] Conductive paths 129 are provided to connect LEDs 109 to an electrical connector 111. The conductive paths may be disposed on an electrically insulating layer 131 or layers disposed on exterior surface 107. In the illustrative embodiment shown in the drawing figures, the conductive paths and insulating layer are provided by means of one or more flexible printed circuits 113 that are permanently disposed on surface 107. As more easily seen in FIG. 6, printed circuit 113 includes an electrically insulating layer 131 that carries conductive paths 129. As will be appreciated by those skilled in the art, other means of providing the electrically conductive paths on the

[0030] Flexible printed circuit 113 has LED's 109 mounted to it in a variety of orientations ranging from 360 degrees to 180 degrees and possibly others depending on the application. Electrical connector 111 is disposed at one end of printed circuit 113. Connector 113 is coupleable to a separate power supply to receive electrical current. Flexible printed circuit 113, in the illustrative embodiment is coated with a non-electrically conductive epoxy that may be infused with optically reflective materials. Flexible printed circuit 113 is adhered to the tube 101 with a heat conducting epoxy to aid in the transmission of the heat from LEDs 109 to tube 101. Flexible printed circuit 113 has mounting holes

134 for receiving LEDs 109 such that the backs of LEDs 109 are in thermal contact with the tube surface 107.

[0031] Tubular heat sink 101 in the illustrative embodiment is formed in the shape of a polygon and may have any number of sides. Although tubular heat sink 101 in the illustrative embodiment is extruded aluminum, tubular heat sink 101 may comprise other thermal conductive material. Fins 105 may vary in number and location depending on particular LED layouts and wattage. In some instances, fins may be added to the exterior surface of tubular heat sink 101. In addition, apertures may be added to the tubular heat sink to enhance heat flow.

[0032] Light source 100 is mounted into a fixture and retained in position by mounting clips 121, 123 as most clearly seen in FIGS. 3, 4, and 5. Each of the clips is shaped so as to engage and retain light source 100. Each clip is affixed on one surface 122, 124 to a light fixture.

[0033] Although light source 100 is shown as comprising an elongate tubular heat sink, other extruded elongate members may be used such as channels.

[0034] In the illustrative embodiment shown, convection cooling by flow of air through tubular heat sink 101 is utilized such that cool or unheated air enters tubular heat sink 101 at its lower end and exits from the upper end as heated air. In higher wattage light sources, rather than utilizing air as the cooling medium, other fluids may be utilized. In particular, convective heat pumping may be used to remove heat from the interior of the heat sink.

[0035] In one particularly advantageous embodiment of the invention, the light source of the invention is configured to replace compact fluorescent lighting in decorative applications.

[0036] As will be appreciated by those skilled in the art, the principles of the invention are not limited to the use of light emitting diodes that emit white light. Different colored light emitting diodes may be used to produce monochromatic light or to produce light that is the combination of different colors.

[0037] Although the invention has been described in terms of illustrative embodiments, it is not intended that the invention be limited to the illustrative embodiments shown and described. It will be apparent to those skilled in the art that various changes and modifications may be made to the embodiments shown and described without departing from the spirit or scope of the invention. It is intended that the invention be limited only by the claims appended hereto.

What is claimed is:

1. A light source comprising:

an elongate thermally conductive member having an outer surface;

at least one solid state light source carried on said elongate member outer surface;

one or more electrical conductors carried by said elongate thermally conductive member and connected to said at least one solid state light source to supply electrical power thereto; and

said elongate thermally conductive member being configured to conduct heat away from said at least one

solid state light source to fluid contained by said elongate thermally conductive member.

2. A light source comprising:

an elongate thermally conductive member having an outer surface;

a plurality of solid state light sources carried on said elongate member outer surface at least some of said solid state light sources being disposed in a first plane and others of said solid state light sources being disposed in a second plane not coextensive with said first plane;

electrical conductors carried by said elongate thermally conductive member and connected to said plurality of solid state light sources to supply electrical power thereto; and

said elongate thermally conductive member being configured to conduct heat away from said solid state light sources to fluid contained by said elongate thermally conductive member.

3. A light source in accordance with claim 2, wherein:

said fluid comprises air.

4. A light source in accordance with claim 3, wherein:

said elongate thermally conductive member comprises one or more heat dissipation protrusions.

5. A light source in accordance with claim 2, wherein:

said elongate thermally conductive member comprises a tube.

6. A light source in accordance with claim 5, wherein:

said tube has a cross-section in the shape of a polygon.

7. A light source in accordance with claim 5, wherein:

said tube has a cross-section having flat portions.

8. A light source in accordance with claim 2, wherein:

said elongate thermally conductive member comprises a channel.

9. A light source in accordance with claim 2, wherein:

said elongate thermally conductive member comprises an extrusion.

10. A light source in accordance with claim 9, wherein:

said extrusion is an aluminum extrusion.

11. A light source in accordance with claim 10, wherein:

said elongate thermally conductive member is a tubular member.

12. A light source in accordance with claim 11, wherein:

said tubular member has a polygon cross-section.

13. A light source in accordance with claim 11, wherein:

said tubular member has a triangular cross-section.

14. A light source in accordance with claim 2, comprising:

a flexible circuit carried on a surface of said elongate thermally conductive member, said flexible circuit comprising said electrical conductors.

15. A light source in accordance with claim 14, wherein:

said flexible circuit comprises a plurality of apertures for receiving said plurality of light emitting diodes.

16. A light source in accordance with claim 15, wherein:

each of said solid state light sources is disposed in a corresponding one of said apertures and affixed in thermally conductive contact with said elongate thermally conductive member.

17. A light source in accordance with claim 2, wherein:

a thermal transfer media disposed therein.

18. A light source in accordance with claim 17, wherein:

said elongate thermally conductive member comprises a flow channel for said thermal transfer media.

19. A light source in accordance with claim 2, comprising:

at least one clip for mounting said elongate thermally conductive member in a fixture.

20. A light source in accordance with claim 2, comprising:

an electrically insulating layer disposed on said elongate thermally conductive member outer surface and carrying said electrical conductors thereon.

21. A light source in accordance with claim 20, wherein:

said electrically insulating layer comprises a plurality of apertures, each aperture receiving one of said solid state light sources; and

each solid state light source of said plurality of solid state light sources being mounted in a corresponding one of said apertures and in thermally conductive contact with said elongate thermally conductive member.

22. A radiation emitting source comprising:

an elongate thermally conductive member having an outer surface;

at least one radiation emitting semiconductor device carried on said elongate member outer surface;

one or more electrical conductors carried by said elongate thermally conductive member and connected to said at least one radiation emitting semiconductor device to supply electrical power thereto; and

said elongate thermally conductive member being configured to conduct heat away from said at least one radiation emitting semiconductor device to fluid contained by said elongate thermally conductive member.

23. A radiation emitting source comprising:

an elongate thermally conductive member having an outer surface;

a plurality of radiation emitting semiconductor devices carried on said elongate member outer surface at least some of said radiation emitting semiconductor devices being disposed in a first plane and others of said radiation emitting semiconductor devices being disposed in a second plane not coextensive with said first plane;

electrical conductors carried by said elongate thermally conductive member and connected to said plurality of light emitting diodes to supply electrical power thereto; and

said elongate thermally conductive member being configured to conduct heat away from said radiation emitting semiconductor devices to fluid contained by said elongate thermally conductive member.

24. A radiation emitting source in accordance with claim 23, wherein:

said fluid comprises air.

25. A radiation emitting source in accordance with claim 24, wherein:

said elongate thermally conductive member comprises one or more heat dissipation protrusions.

26. A radiation emitting source in accordance with claim 23, wherein:

said elongate thermally conductive member comprises a tube.

27. A radiation emitting source in accordance with claim 26, wherein:

said tube has a cross-section in the shape of a polygon.

28. A radiation emitting source in accordance with claim 26, wherein:

said tube has a cross-section having flat portions.

29. A radiation emitting source in accordance with claim 23, wherein:

said elongate thermally conductive member comprises a channel.

30. A radiation source in accordance with claim 23, wherein:

said elongate thermally conductive member comprises an extrusion.

31. A radiation emitting source in accordance with claim 30, wherein:

said extrusion is an aluminum extrusion.

32. A radiation emitting source in accordance with claim 31, wherein:

said elongate thermally conductive member is a tubular member.

33. A radiation emitting source in accordance with claim 32, wherein:

said tubular member has a polygon cross-section.

34. A radiation emitting source in accordance with claim 32, wherein:

said tubular member has a triangular cross-section.

35. A radiation emitting source in accordance with claim 23, comprising:

a flexible circuit carried on a surface of said elongate thermally conductive member, said flexible circuit comprising said electrical conductors.

36. A radiation source in accordance with claim 35, wherein:

said flexible circuit comprises a plurality of apertures for receiving said plurality of light emitting diodes.

37. A radiation source in accordance with claim 36, wherein:

each of said radiation emitting semiconductor devices is disposed in a corresponding one of said apertures and affixed in thermally conductive contact with said elongate thermally conductive member.

38. A radiation emitting source in accordance with claim 23, wherein:

a thermal transfer media disposed therein.

39. A radiation source in accordance with claim 38, wherein:

said elongate thermally conductive member comprises a flow channel for said thermal transfer media.

40. A radiation emitting source in accordance with claim 23, comprising:

at least one clip for mounting said elongate thermally conductive member in a fixture.

41. A radiation emitting source in accordance with claim 23, comprising:

an electrically insulating layer disposed on said elongate thermally conductive member outer surface and carrying said electrical conductors thereon.

42. A radiation emitting source in accordance with claim 41, wherein:

said electrically insulating layer comprises a plurality of apertures, each aperture receiving one of said radiation emitting semiconductor devices; and

each radiation emitting semiconductor device of said plurality of radiation emitting semiconductor devices being mounted in a corresponding one of said apertures and in thermally conductive contact with said elongate thermally conductive member.

43. A radiation emitting source comprising:

an elongate thermally conductive member having an outer surface;

at least one radiation emitting solid state device carried on said elongate member outer surface;

one or more electrical conductors carried by said elongate thermally conductive member and connected to said at least one radiation emitting solid state device to supply electrical power thereto; and

said elongate thermally conductive member being configured to conduct heat away from said at least one radiation emitting solid state device to fluid contained by said elongate thermally conductive member.

44. A radiation emitting source comprising:

an elongate thermally conductive member having an outer surface;

a plurality of radiation emitting solid state devices carried on said elongate member outer surface at least some of said radiation emitting solid state devices being disposed in a first plane and others of said radiation emitting solid state devices being disposed in a second plane not coextensive with said first plane;

electrical conductors carried by said elongate thermally conductive member and connected to said plurality of light emitting diodes to supply electrical power thereto; and

said elongate thermally conductive member being configured to conduct heat away from said radiation emitting solid state devices to fluid contained by said elongate thermally conductive member.

45. A radiation emitting source in accordance with claim 44, wherein:

said fluid comprises air.

46. A radiation emitting source in accordance with claim 45, wherein:

said elongate thermally conductive member comprises one or more heat dissipation protrusions.

47. A radiation emitting source in accordance with claim 44, wherein:

said elongate thermally conductive member comprises a tube.

48. A radiation emitting source in accordance with claim 47, wherein:

said tube has a cross-section in the shape of a polygon.

49. A radiation emitting source in accordance with claim 47 wherein:

said tube has a cross-section having flat portions.

50. A radiation emitting source in accordance with claim 44, wherein:

said elongate thermally conductive member comprises a channel.

51. A radiation emitting source in accordance with claim 44, wherein:

said elongate thermally conductive member comprises an extrusion.

52. A radiation emitting source in accordance with claim 51, wherein:

said extrusion is an aluminum extrusion.

53. A radiation emitting source in accordance with claim 52, wherein:

said elongate thermally conductive member is a tubular member.

54. A radiation emitting source in accordance with claim 53, wherein:

said tubular member has a polygon cross-section.

55. A radiation emitting source in accordance with claim 53, wherein:

said tubular member has a triangular cross-section.

56. A radiation emitting source in accordance with claim 54, comprising:

a flexible circuit carried on a surface of said elongate thermally conductive member, said flexible circuit comprising said electrical conductors.

57. A radiation source in accordance with claim 56, wherein:

said flexible circuit comprises a plurality of apertures for receiving said plurality of light emitting diodes.

58. A radiation source in accordance with claim 57, wherein:

each of said radiation emitting solid state devices is disposed in a corresponding one of said apertures and affixed in thermally conductive contact with said elongate thermally conductive member.

59. A radiation emitting source in accordance with claim 44, wherein:

a thermal transfer media disposed therein.

60. A radiation emitting source in accordance with claim 59, wherein:

said elongate thermally conductive member comprises a flow channel for said thermal transfer media.

61. A radiation emitting source in accordance with claim 44, comprising:

at least one clip for mounting said elongate thermally conductive member in a fixture.

62. A radiation emitting source in accordance with claim 44, comprising:

an electrically insulating layer disposed on said elongate thermally conductive member outer surface and carrying said electrical conductors thereon.

63. A radiation emitting source in accordance with claim 62, wherein:

said electrically insulating layer comprises a plurality of apertures, each aperture receiving one of said radiation emitting solid state devices; and

each radiation emitting solid state device of said plurality of radiation emitting solid state devices being mounted in a corresponding one of said apertures and in thermally conductive contact with said elongate thermally conductive member.

* * * * *